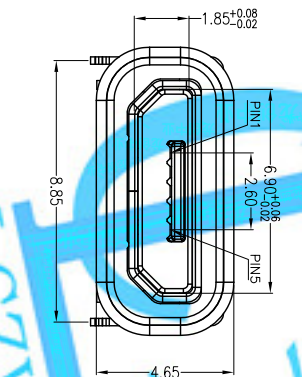
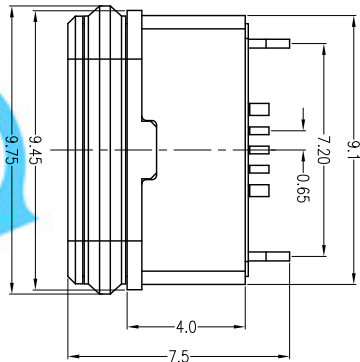
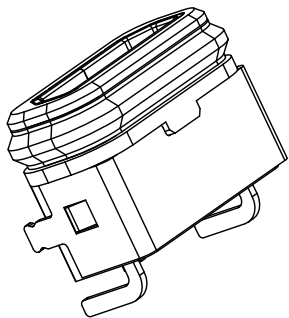
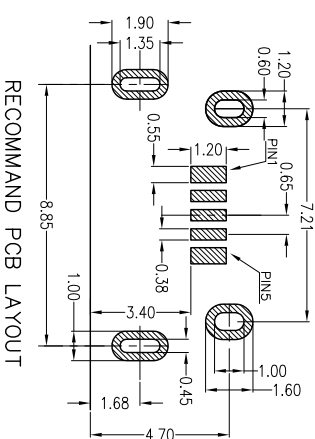


- 1. Material/Plated
- 1.1 Housing: High temperature thermoplastic, Black UL 94V-0.
- 1.2 Cover: High temperature thermoplastic, Black UL 94V-0.
- 1.3 Terminal: Copper Alloy, Gold Flash Plated At Contact Area, Gold Plated At Solder Area, Nickel Underplated Overall
- 1.4 Shell: Stainless steel, Nickel plated Overall
- 1.5 Out Shell: Stainless steel, Nickel plated Overall
- 1.6 Ring: Silicon
- 1.7 Epoxy: Epoxy, Black
- 2. Electrical Performance
- 2.1 Rated Voltage: 30V AC
- 2.2 Rated Current: 1.5Pin: 3.0A Max. 2, 3, 4Pin: 1.0A Max.
- 2.3 Contact Resistance: 30mΩ Max.
- 2.4 Insulation Resistance: 100MΩ Min.
- 2.5 Dielectric Strength: 100V AC
- 3. Mechanical Performance
- 3.1 Insertion Force: 35N Max.
- 3.2 Withdrawal Force: 8-35N
- 3.3 Durability: 10000 Cycles
- 4. Operating Temperature: -25° C To +85° C
- 5. Waterproof: IPX8



Sealing method(for reference only)

				DRAWN		Tom	2018-06-13	DIMENSION TOLERANCE		龙创中业电子科技有限公司（东莞）有限公司	
								X X.X ±0.35			
				CHECKED		Ango	2018-06-13	X.XX ±0.25 X.XXX ±0.15			
				APPROVE		Kevin	2018-06-13	GENERAL ANGLE: ±3°			
								UNIT: mm	TITLE		Micro USB B 5P Waterproof DIP
A				NEW RELEASE		Tom	2018-06-13		PART NO.		UMX-023H2AP
REV.				DESCRIPTION		ECN NO.	NAME	DATE	DWG. NO.		
				REVISIONS				SCALE: N/A		SHEET: 1 OF 1	
								LEVEL		C31	
											
											